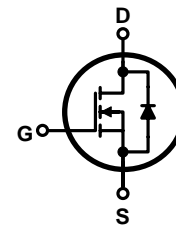
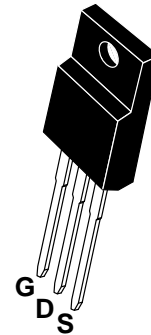


PIN Connection TO-220F

| | | |
|------------------------|------|----------|
| V_{DSS} | 600 | V |
| I_D | 10 | A |
| $P_D (T_C=25^\circ C)$ | 125 | W |
| $R_{DS(ON)}$ | 0.63 | Ω |



Marking Diagram



Y = Year
 A = Assembly Location
 WW = Work Week
 FIR10N60F = Specific Device Code

Features

- Fast Switching
- ESD Improved Capability
- Low Gate Charge (Typical Data:60nC)
- Low Reverse transfer capacitances(Typical:28pF)
- 100% Single Pulse avalanche energy Test

Applications

Power switch circuit of adaptor and charger.

Absolute (Tc= 25°C unless otherwise specified)

| Symbol | Parameter | Rating | Units |
|----------------|--|-----------------|-------|
| V_{DSS} | Drain-to-Source Voltage | 600 | V |
| I_D | Continuous Drain Current | 10 | A |
| | Continuous Drain Current $T_C = 100^\circ C$ | 6.4 | A |
| I_{DM}^{a1} | Pulsed Drain Current | 40 | A |
| V_{GS} | Gate-to-Source Voltage | ± 20 | V |
| E_{AS}^{a2} | Single Pulse Avalanche Energy | 300 | mJ |
| E_{AR}^{a1} | Avalanche Energy ,Repetitive | 30 | mJ |
| I_{AR}^{a1} | Avalanche Current | 8.0 | A |
| dv/dt^{a3} | Peak Diode Recovery dv/dt | 5.5 | V/ns |
| P_D | Power Dissipation | 125 | W |
| | Derating Factor above 25°C | 1.0 | W/°C |
| $V_{ESD(G-S)}$ | Gate source ESD (HBM-C= 100pF, R=1.5k Ω) | 4000 | V |
| T_J, T_{stg} | Operating Junction and Storage Temperature Range | 150, -55 to 150 | °C |
| T_L | Maximum Temperature for Soldering | 300 | °C |

Electrical Characteristics (Tc= 25°C unless otherwise specified)

| OFF Characteristics | | | | | | |
|--|-----------------------------------|---|--------|------|------|-------|
| Symbol | Parameter | Test Conditions | Rating | | | Units |
| | | | Min. | Typ. | Max. | |
| V _{DSS} | Drain to Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 600 | -- | -- | V |
| Δ BV _{DSS} / Δ T _J | Bvdss Temperature Coefficient | I _D =250uA, Reference 25°C | -- | 0.74 | -- | V/°C |
| I _{DSS} | Drain to Source Leakage Current | V _{DS} = 600V, V _{GS} = 0V, T _a = 25°C | -- | -- | 25 | μA |
| | | V _{DS} = 480V, V _{GS} = 0V, T _a = 125°C | -- | -- | 250 | |
| V _{GSO} | Gate Source Breakdown Voltage | I _{GS} = ±1mA (Open Drain) | ±20 | | | V |
| I _{GSS(F)} | Gate to Source Forward Leakage | V _{GS} = +20V | -- | -- | 10 | μA |
| I _{GSS(R)} | Gate to Source Reverse Leakage | V _{GS} = -20V | -- | -- | -10 | μA |

| ON Characteristics | | | | | | |
|--------------------------------|-------------------------------|--|--------|------|------|-------|
| Symbol | Parameter | Test Conditions | Rating | | | Units |
| | | | Min. | Typ. | Max. | |
| R _{DS(ON)} | Drain-to-Source On-Resistance | V _{GS} =10V, I _D =5A | -- | 0.63 | 0.75 | Ω |
| V _{GS(TH)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250μA | 2.0 | 3.0 | 4.0 | V |
| Pulse width tp ≤ 380μs, δ ≤ 2% | | | | | | |

| Dynamic Characteristics | | | | | | |
|--------------------------------|------------------------------|--|--------|------|------|-------|
| Symbol | Parameter | Test Conditions | Rating | | | Units |
| | | | Min. | Typ. | Max. | |
| g _{fs} | Forward Transconductance | V _{DS} =15V, I _D =5.0A | -- | 8.5 | -- | S |
| C _{iss} | Input Capacitance | V _{GS} = 0V V _{DS} = 25V f = 1.0MHz | -- | 1430 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 160 | -- | |
| C _{rss} | Reverse Transfer Capacitance | | -- | 28 | -- | |

| Resistive Switching Characteristics | | | | | | |
|--|---------------------------------|--|--------|------|------|-------|
| Symbol | Parameter | Test Conditions | Rating | | | Units |
| | | | Min. | Typ. | Max. | |
| t _{d(ON)} | Turn-on Delay Time | I _D = 10.0A V _{DD} = 300V V _{GS} = 10V R _G = 4.7Ω | -- | 20 | -- | ns |
| t _r | Rise Time | | -- | 20 | -- | |
| t _{d(OFF)} | Turn-Off Delay Time | | -- | 55 | -- | |
| t _f | Fall Time | | -- | 30 | -- | |
| Q _g | Total Gate Charge | I _D = 10.0A V _{DD} = 480V V _{GS} = 10V | -- | 60 | 70 | nC |
| Q _{gs} | Gate to Source Charge | | -- | 12 | -- | |
| Q _{gd} | Gate to Drain ("Miller") Charge | | -- | 28 | -- | |

| Source-Drain Diode Characteristics | | | | | | |
|--|--|--|--------|------|------|-------|
| Symbol | Parameter | Test Conditions | Rating | | | Units |
| | | | Min. | Typ. | Max. | |
| I_S | Continuous Source Current (Body Diode) | | -- | -- | 10 | A |
| I_{SM} | Maximum Pulsed Current (Body Diode) | | -- | -- | 40 | A |
| V_{SD} | Diode Forward Voltage | $I_S=10.0A, V_{GS}=0V$ | -- | -- | 1.5 | V |
| t_{rr} | Reverse Recovery Time | $I_S=10.0A, T_j = 25^\circ C$ $dI_F/dt=100A/us,$ $V_{GS}=0V$ | -- | 600 | -- | ns |
| Q_{rr} | Reverse Recovery Charge | | -- | 4.3 | -- | nC |
| I_{RRM} | Reverse Recovery Current | | -- | 13 | -- | A |
| Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$ | | | | | | |

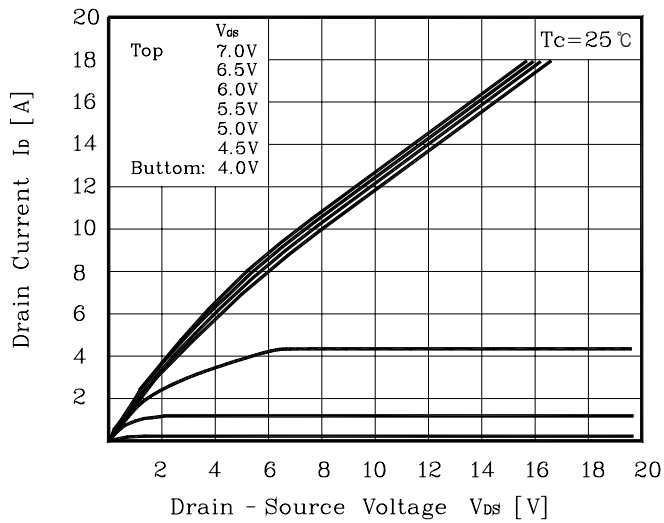
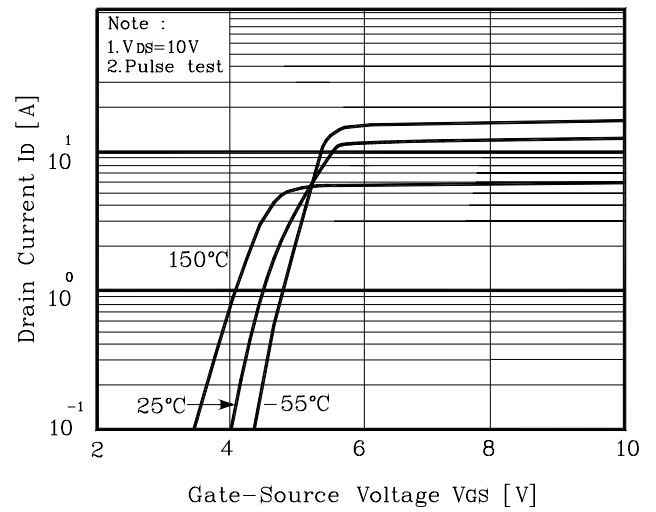
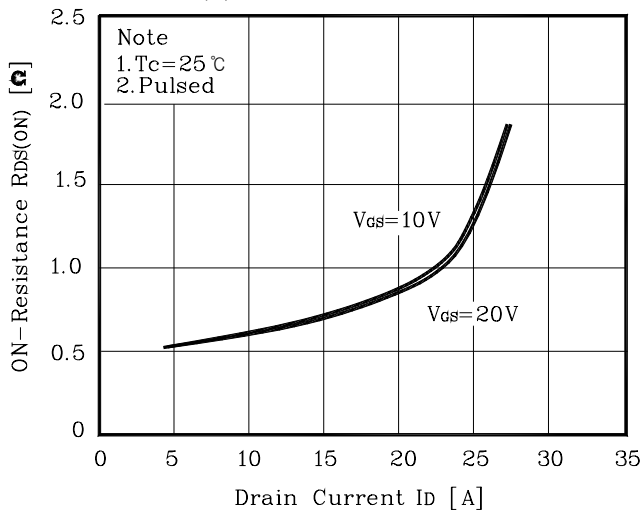
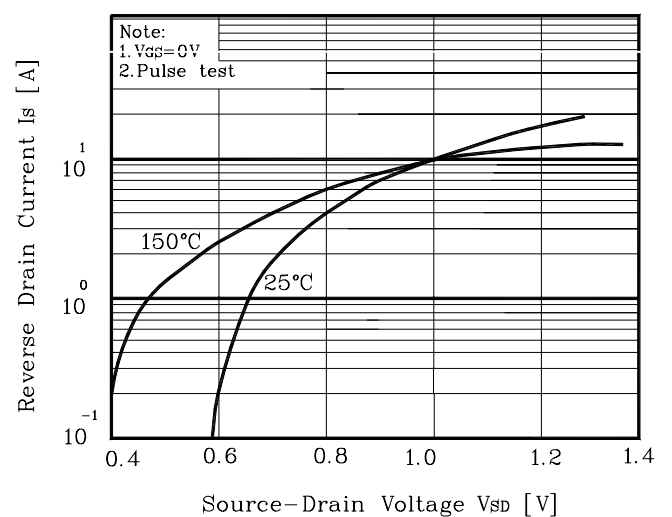
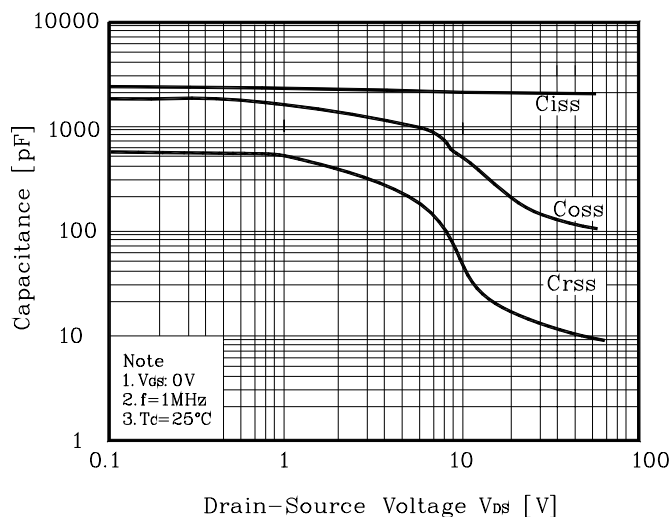
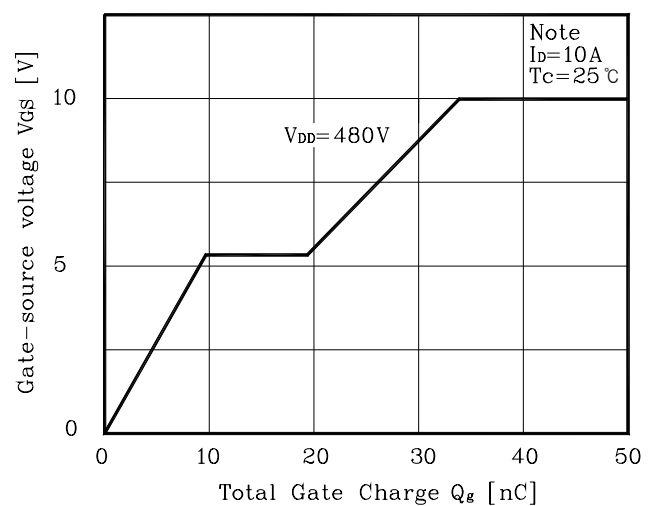
| Symbol | Parameter | Typ. | Units |
|-----------------|---------------------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case | 1.0 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient | 62 | $^\circ C/W$ |

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

^{a2}: $L=10.0mH, I_P=10A, Start T_j=25^\circ C$

^{a3}: $I_{SD}=10A, di/dt \leq 100A/us, V_{DD} \leq BV_{DS}, Start T_j=25^\circ C$

Electrical Characteristic Curves

Fig. 1 $I_D - V_{DS}$

Fig. 2 $I_D - V_{GS}$

Fig. 3 $R_{DS(on)} - I_D$

Fig. 4 $I_S - V_{SD}$

Fig. 5 Capacitance - V_{DS}

Fig. 6 $V_{GS} - Q_G$


Electrical Characteristic Curves

Fig. 7 $V_{DSS} - T_J$

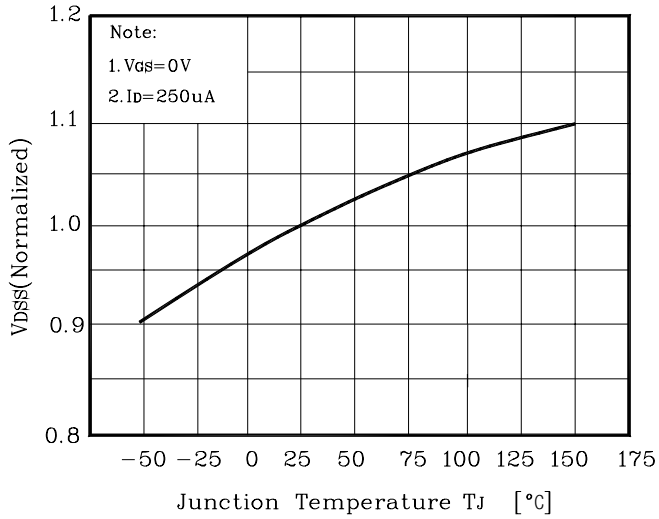


Fig.8 $R_{DS(on)} - T_J$

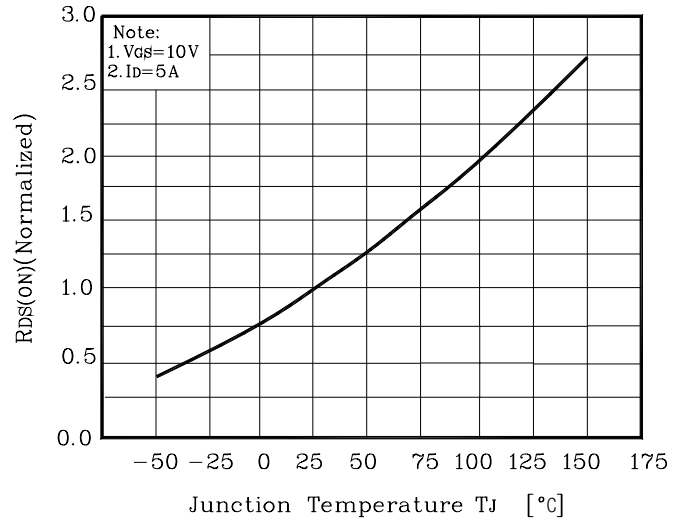


Fig. 9 $I_D - T_C$

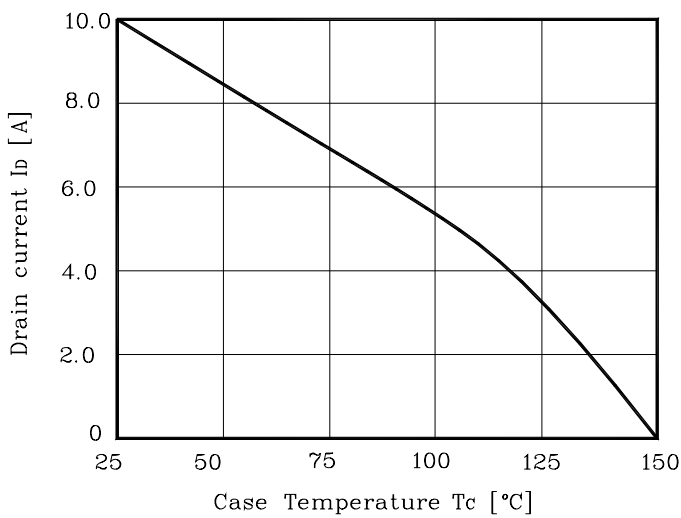


Fig. 10 Safe Operating Area

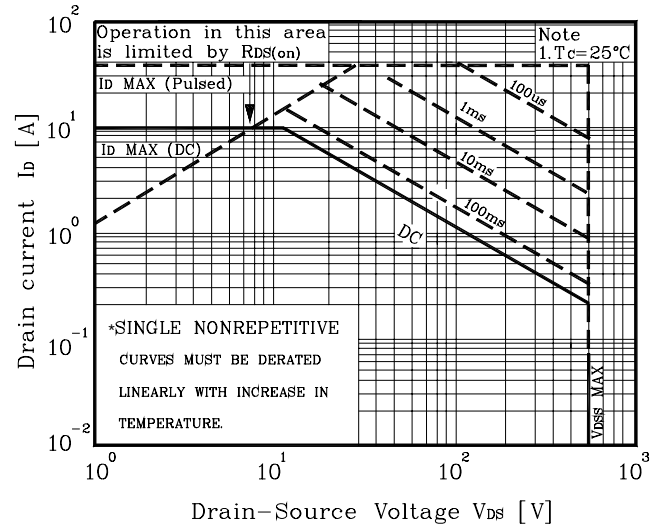


Fig. 10 Gate Charge Test Circuit & Waveform

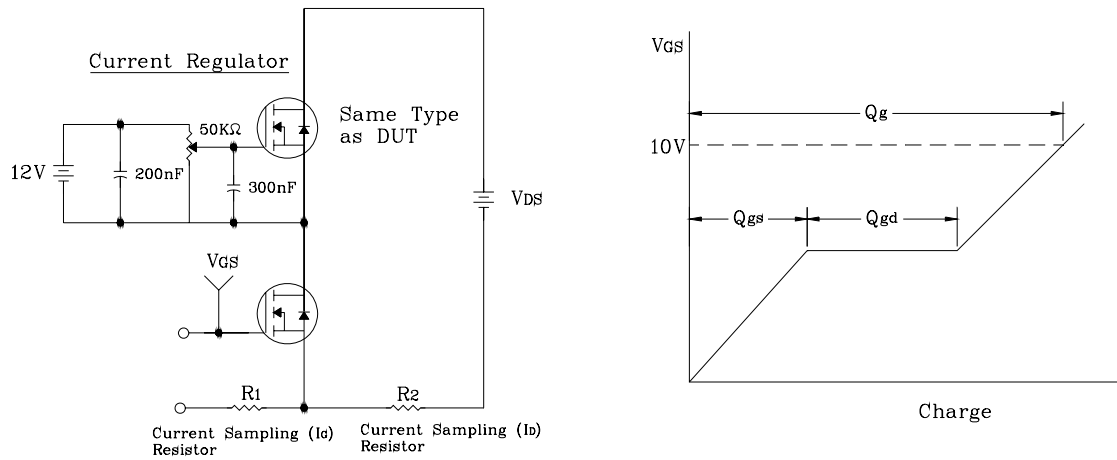


Fig. 11 Resistive Switching Test Circuit & Waveform

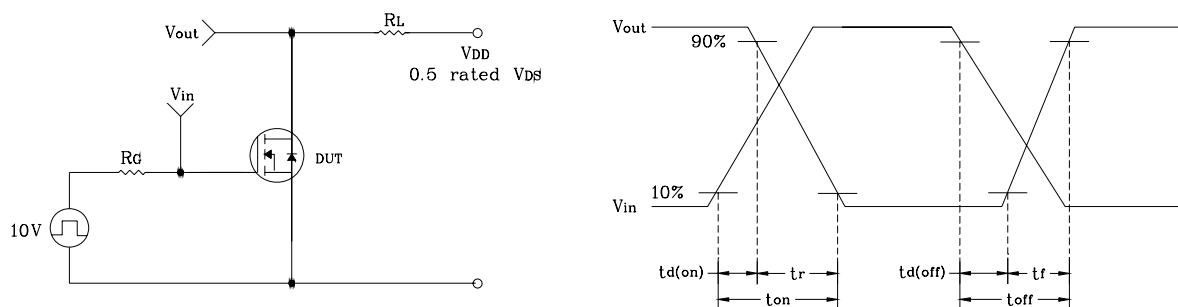


Fig. 12 EAS Test Circuit & Waveform

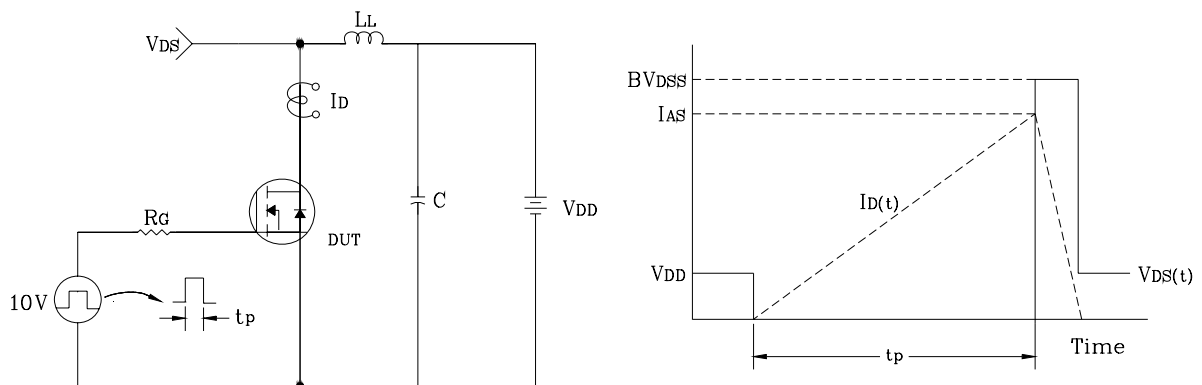
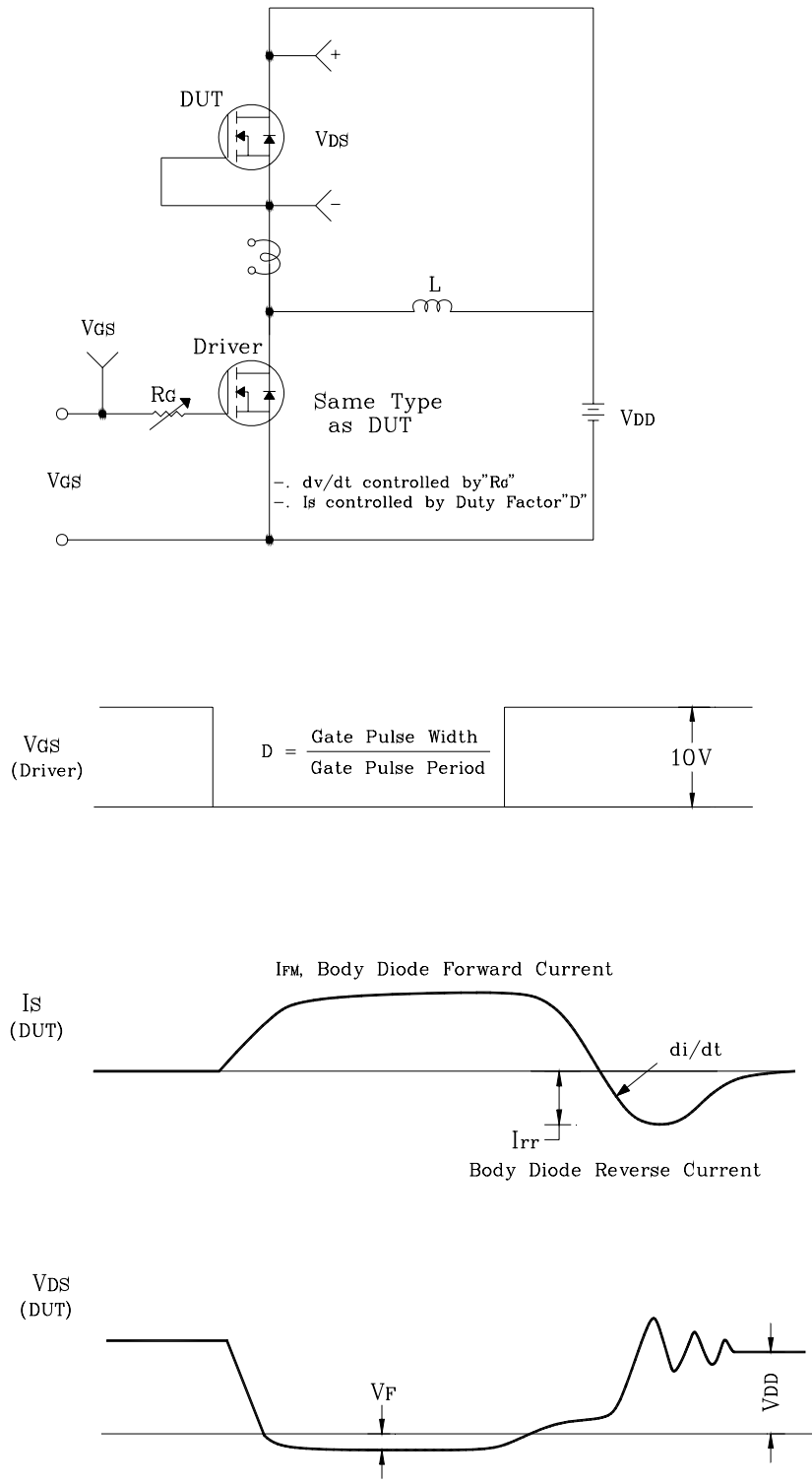
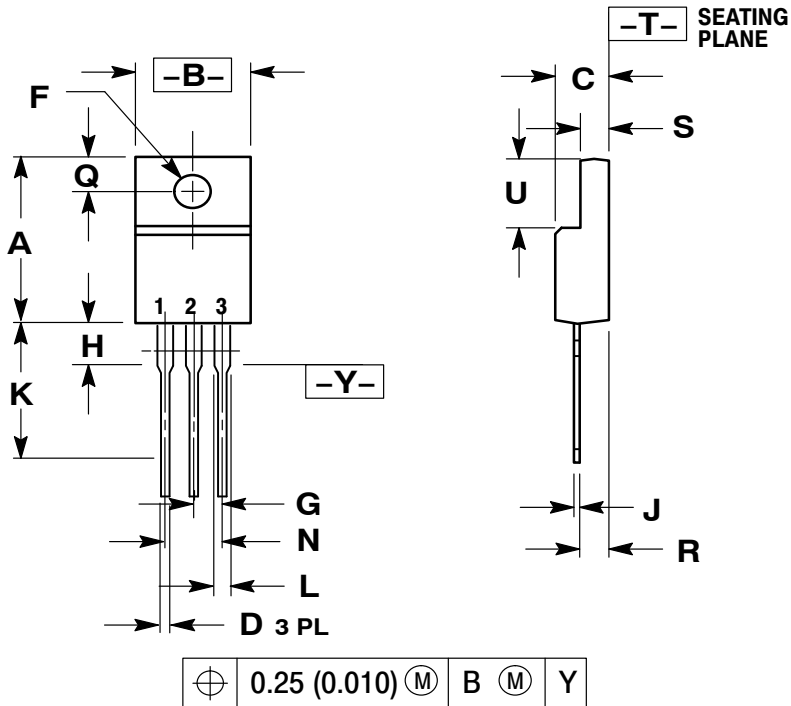


Fig. 13 Diode Reverse Recovery Time Test Circuit & Waveform


Package Dimensions

TO-220F



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH
3. 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.617 | 0.635 | 15.67 | 16.12 |
| B | 0.392 | 0.419 | 9.96 | 10.63 |
| C | 0.177 | 0.193 | 4.50 | 4.90 |
| D | 0.024 | 0.039 | 0.60 | 1.00 |
| F | 0.116 | 0.129 | 2.95 | 3.28 |
| G | 0.100 BSC | | 2.54 BSC | |
| H | 0.118 | 0.135 | 3.00 | 3.43 |
| J | 0.018 | 0.025 | 0.45 | 0.63 |
| K | 0.503 | 0.541 | 12.78 | 13.73 |
| L | 0.048 | 0.058 | 1.23 | 1.47 |
| N | 0.200 BSC | | 5.08 BSC | |
| Q | 0.122 | 0.138 | 3.10 | 3.50 |
| R | 0.099 | 0.117 | 2.51 | 2.96 |
| S | 0.092 | 0.113 | 2.34 | 2.87 |
| U | 0.239 | 0.271 | 6.06 | 6.88 |